



# PJX8838

## 50V N-Channel Enhancement Mode MOSFET– ESD Protected

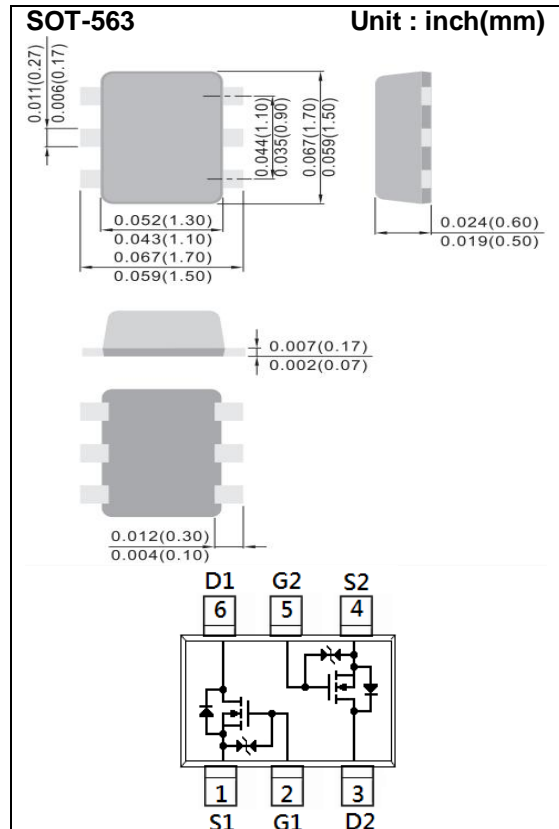
**Voltage** 50 V **Current** 360mA

### Features

- RDS(ON) , VGS@10V, ID@500mA<1.45Ω
- RDS(ON) , VGS@4.5V, ID@200mA<1.95Ω
- RDS(ON) , VGS@2.5V, ID@100mA<4.0Ω
- RDS(ON) , VGS@1.8V, ID@10mA<6.0Ω
- Advanced Trench Process Technology
- ESD Protected 2KV HBM
- Specially Designed for Relay driver, Speed line drive, etc.
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. (Halogen Free)

### Mechanical Data

- Case: SOT-563 Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.00009 ounces, 0.0026 grams
- Marking: X38



### Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Drain-Source Voltage	V <sub>DS</sub>	50	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	360	mA
Pulsed Drain Current	I <sub>DM</sub>	1200	mA
Power Dissipation	P <sub>D</sub>	T <sub>A</sub> =25°C	300
		Derate above 25°C	2.4
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~150	°C
Typical Thermal resistance	R <sub>θJA</sub>	417	°C/W
- Junction to Ambient (Note 3)			



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## Electrical Characteristics ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	50	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.86	1.0	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=500mA$	-	1.2	1.45	$\Omega$
		$V_{GS}=4.5V, I_D=200mA$	-	1.3	1.95	
		$V_{GS}=2.5V, I_D=100mA$	-	1.7	4.0	
		$V_{GS}=1.8V, I_D=10mA$	-	4.0	6.0	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=50V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 10$	$\mu A$
<b>Dynamic</b> (Note 4)						
Total Gate Charge	$Q_g$	$V_{DS}=25V, I_D=500mA,$ $V_{GS}=4.5V$	-	0.95	-	nC
Gate-Source Charge	$Q_{gs}$		-	0.34	-	
Gate-Drain Charge	$Q_{gd}$		-	0.32	-	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V,$ $f=1.0MHz$	-	36	-	pF
Output Capacitance	$C_{oss}$		-	11	-	
Reverse Transfer Capacitance	$C_{rss}$		-	6.6	-	
Turn-On Delay Time	$t_{d(on)}$		-	2.3	-	
Turn-On Rise Time	$t_r$	$V_{DD}=25V, I_D=500mA,$ $V_{GS}=10V,$ $R_G=6\Omega$ (Note 1,2)	-	20	-	
Turn-Off Delay Time	$t_{d(off)}$	-	7	-		
Turn-Off Fall Time	$t_f$	-	20	-		
<b>Drain-Source Diode</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$	---	-	-	500	mA
Diode Forward Voltage	$V_{SD}$	$I_S=500mA, V_{GS}=0V$	-	0.9	1.5	V

NOTES :

1. Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics.
3.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. mounted on a 1 inch square pad of copper
4. Guaranteed by design, not subject to production testing.



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## TYPICAL CHARACTERISTIC CURVES

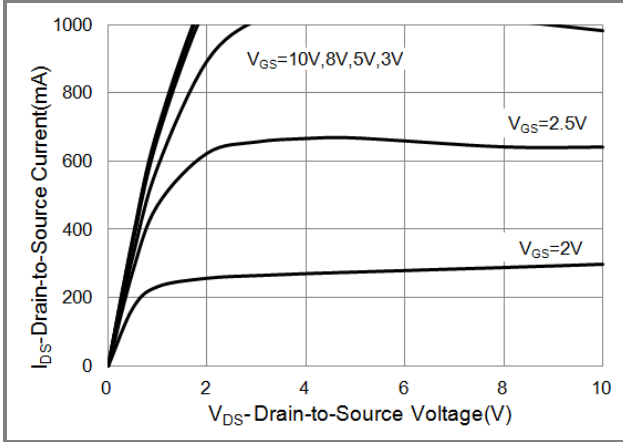


Fig.1 On-Region Characteristics

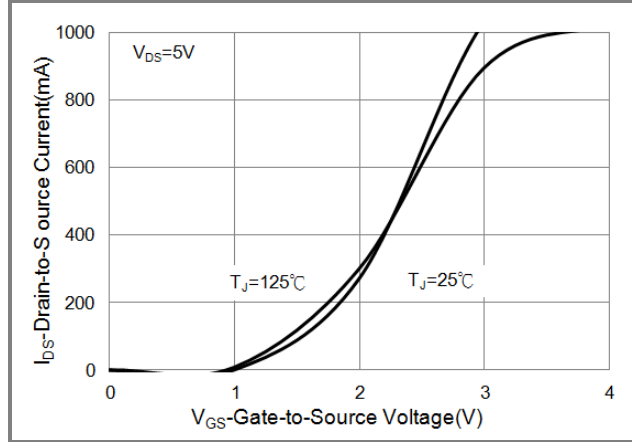


Fig.2 Transfer Characteristics

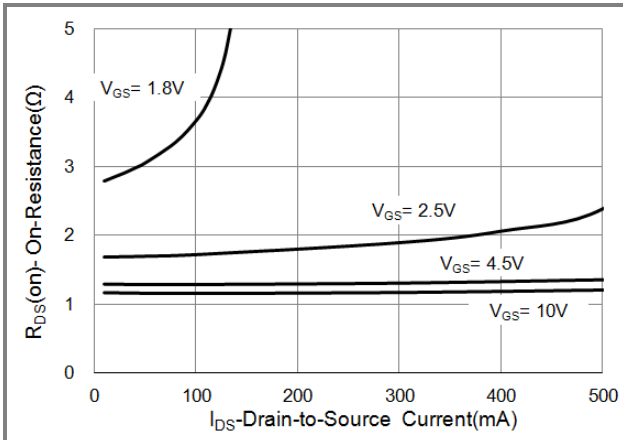


Fig.3 On-Resistance vs. Drain Current

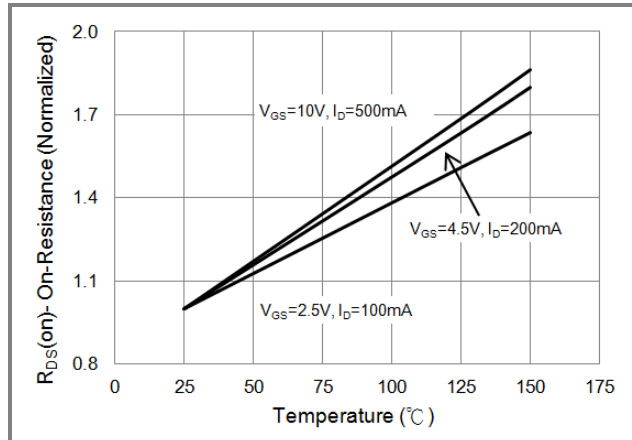


Fig.4 On-Resistance vs. Junction temperature

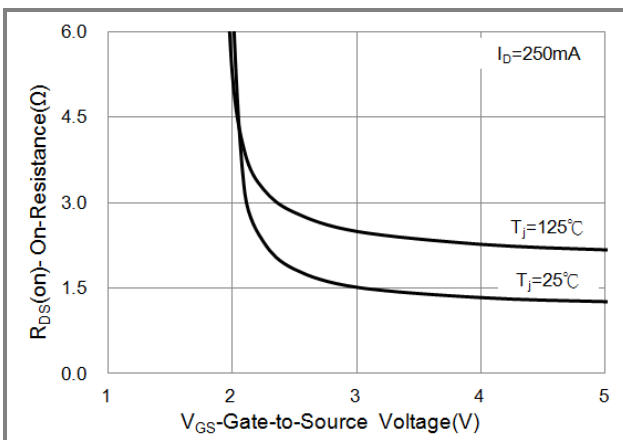


Fig.5 On-Resistance Variation with VGS.

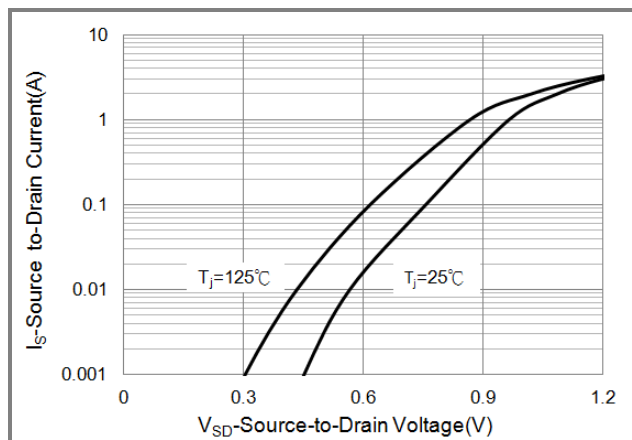


Fig.6 Body Diode Characteristics



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## TYPICAL CHARACTERISTIC CURVES

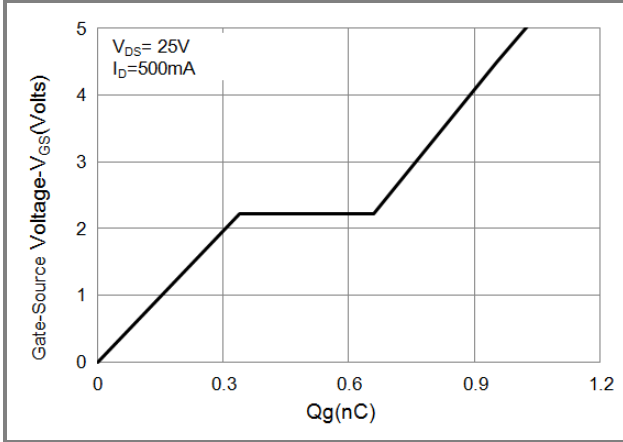


Fig.7 Gate-Charge Characteristics

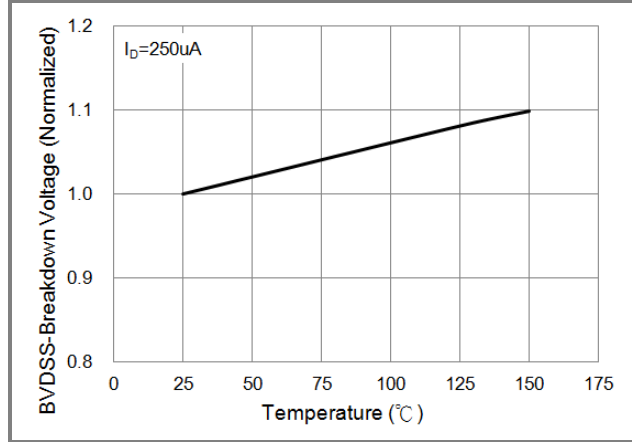


Fig.8 Breakdown Voltage Variation vs. Temperature

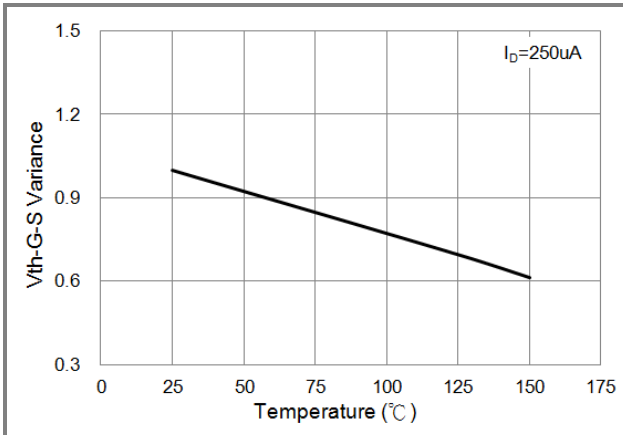


Fig.9 Threshold Voltage Variation with Temperature.

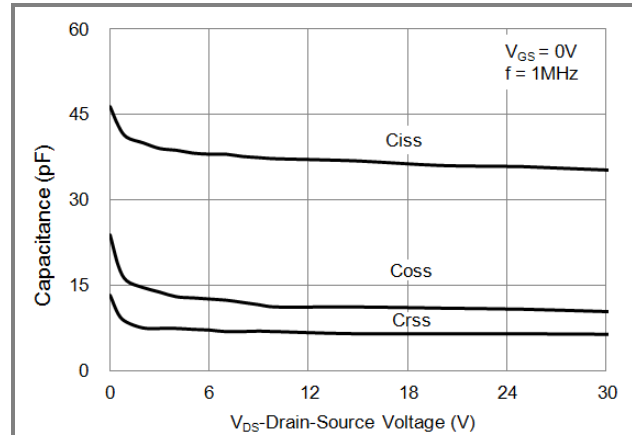


Fig.10 Capacitance vs. Drain-Source Voltage.

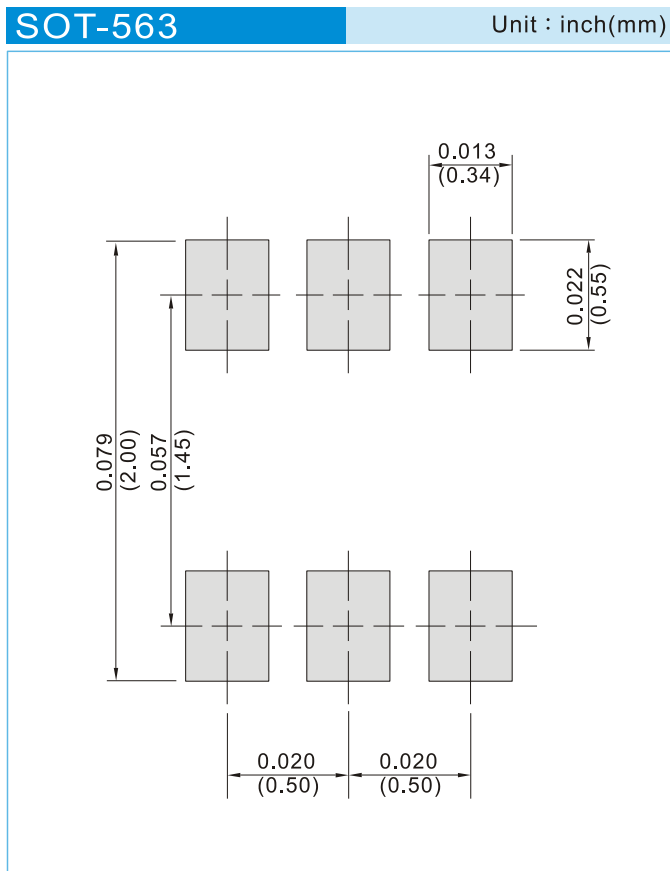


# PJX8838

## PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJX8838_R1_00002	SOT-563	8K pcs / 7" reel	X38	Halogen free
PJX8838_R2_00002	SOT-563	20K pcs / 13" reel	X38	Halogen free

## MOUNTING PAD LAYOUT





## PJX8838

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